

Ordering number : EN\*4852B

CMOS LSI



## LC89512W

### CD-ROM Error Correction LSI with Built-In SCSI Interface

#### Preliminary

#### Overview

The LC89512W integrates a real-time error correction circuit and a SCSI interface in a single chip.

#### Functions

- CD-ROM error correction function, subcode readout function, SCSI interface

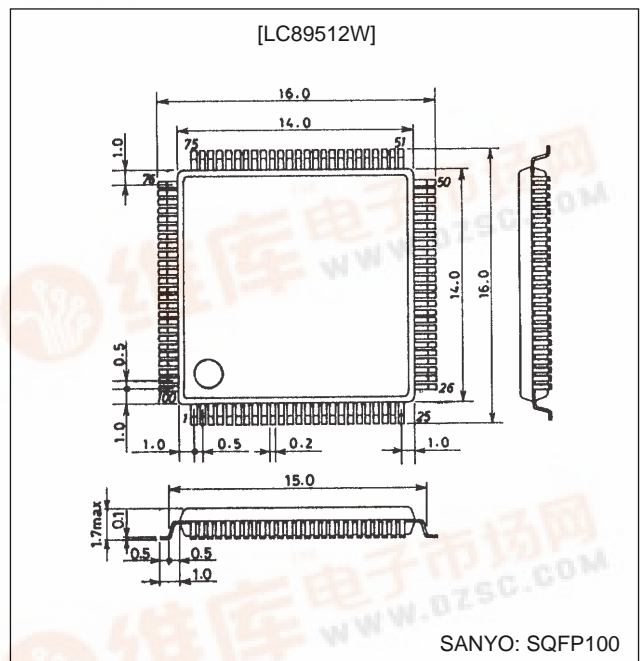
#### Features

- Support for double-speed drives at an operating frequency of 16.9344 MHz  
Either SRAM (120 ns), DRAM (80 ns) or pseudo SRAM (85 ns) can be used.
- Support for quad-speed drives at an operating frequency of 33.8688 MHz  
SRAM (70 ns) must be used.
- Built-in SCSI interface with built-in 48 mA sink buffer (Only the TARGET function is supported.)
- Built-in 12-byte output FIFO for sub-CPU to host computer data transmission
- Built-in 12-byte input FIFO for host computer to sub-CPU data transmission
- Subcode data can be written to buffer RAM and the sub-CPU can read the subcode values by connecting the LC89512 to the CD-DSP subcode pin.
- Sub-CPU access of buffer RAM through the LC89512
- Built-in function for buffer RAM internal data transfer
- Pseudo-SRAM (128-kword × 8-bit and smaller) can be used.
- DRAM (two 256-kword × 4-bit chips or two 1-Mword × 4-bit chips) can be used.
- Transfer speeds:  
2.8 MB/second (asynchronous mode) (for CD-ROM decode only operation)  
4.2 MB/second (synchronous mode) (CD-ROM decode operation is not supported in synchronous mode)  
Both of these transfer modes use a 16.9344 MHz clock. (The transfer speed depends on the frequency used.)
- Operating frequencies: 16.9344 MHz (up to double speed), 33.8688 (quad speed)

#### Package Dimensions

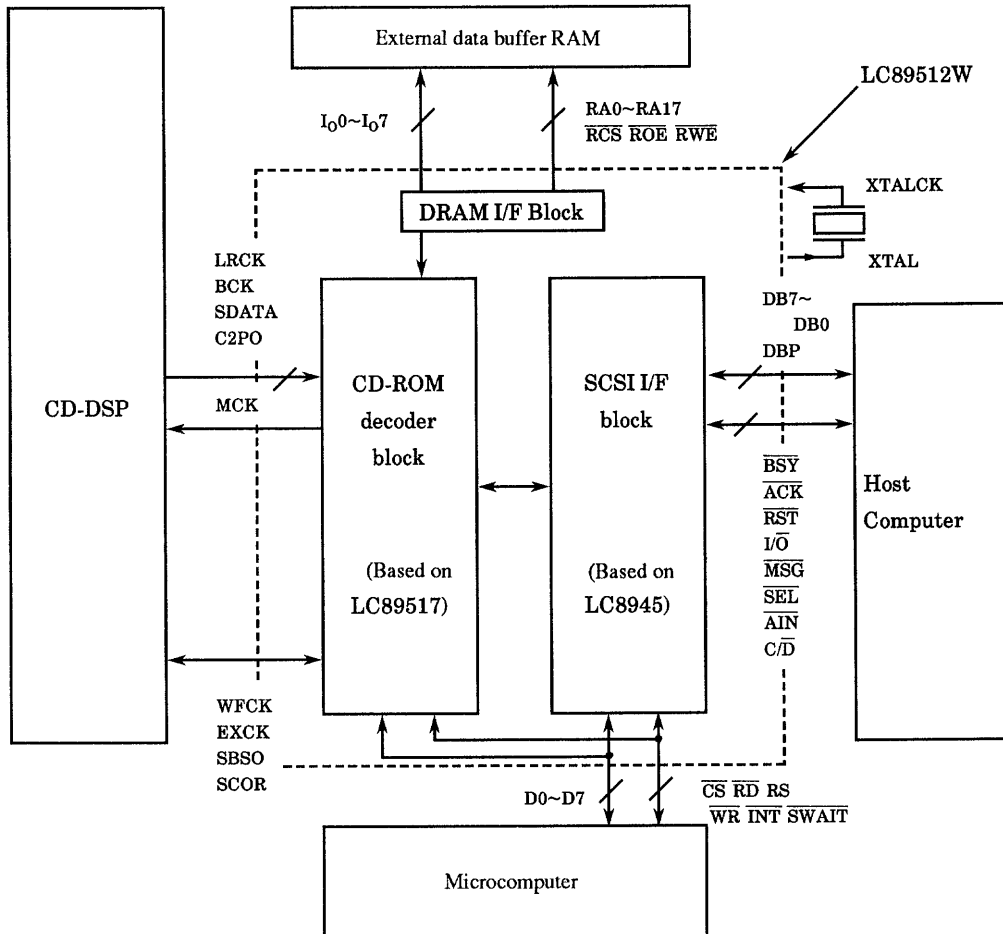
unit: mm

#### 3181A-SQFP100



# LC89512W

## Block Diagram



## LC89512W

### Pin Functions

Type: I: Input pin, O: Output pin, B: Bidirectional pin, P: Power supply pin, NC: No connection pin

Pin No.	Pin	Type	Function
1	$\overline{DB7}$	B	SCSI connection
2	V <sub>SS1</sub>	P	
3	$\overline{DBP}$	B	SCSI connection
4	$\overline{ATN}$	B	SCSI connection
5	V <sub>SS1</sub>	P	
6	$\overline{BSY}$	B	SCSI connection
7	$\overline{ACK}$	B	SCSI connection
8	V <sub>SS1</sub>	P	
9	$\overline{RST}$	B	SCSI connection
10	$\overline{MSG}$	B	SCSI connection
11	V <sub>SS1</sub>	P	
12	$\overline{SEL}$	B	SCSI connection
13	C/D	B	SCSI connection
14	V <sub>SS1</sub>	P	
15	$\overline{REQ}$	B	SCSI connection
16	I/O	B	SCSI connection
17	V <sub>SS0</sub>	P	
18	I <sub>O0</sub>	B	Data buffer RAM data signals These pins have built-in pull-up resistors.
19	I <sub>O1</sub>	B	
20	I <sub>O2</sub>	B	
21	I <sub>O3</sub>	B	
22	I <sub>O4</sub>	B	
23	I <sub>O5</sub>	B	
24	I <sub>O6</sub>	B	
25	I <sub>O7</sub>	B	
26	$\overline{INT1}$	O	SCSI block interrupt request signal output (set using a register)
27	V <sub>SS0</sub>	P	
28	V <sub>SS0</sub>	P	
29	D0	B	Microprocessor data signals These pins have built-in pull-up resistors.
30	D1	B	
31	D2	B	
32	D3	B	
33	D4	B	
34	D5	B	
35	D6	B	
36	D7	B	
37	$\overline{INT0}$	O	Microprocessor interrupt request signal output
38	XTALCK	I	Crystal oscillator circuit input
39	XTAL	O	Crystal oscillator circuit output
40	V <sub>SS0</sub>	P	
41	V <sub>DD</sub>	P	
42	RA0	O	Data buffer RAM address signal outputs
43	RA1	O	
44	RA2	O	
45	RA3	O	
46	RA4	O	
47	RA5	O	
48	RA6	O	
49	RA7	O	
50	RA8	O	
51	RA9	O	
52	RA10	O	
53	RA11	O	

Continued on next page.

## LC89512W

Continued from preceding page.

Pin No.	Pin	Type	Function
54	RA12	O	Data buffer RAM address signal outputs
55	RA13	O	
56	RA14	O	
57	RA15	O	
58	RA16	O	
59	RA17	O	
60	V <sub>DD</sub>	P	
61	V <sub>SS0</sub>	P	
62	RESET	I	Reset
63	TEST1	I	Test inputs. These pins should be tied low in normal operation.
64	TEST2	I	
65	TEST3	I	
66	WFCK	I	Subcode I/O
67	SBSO	I	
68	SCOR	I	
69	SDATA	I	Serial data input
70	BCK	I	Serial data input clock
71	LRCK	I	44.1 kHz strobe signal input
72	C2PO	I	C2 pointer input
73	RD	I	Microprocessor data read signal input
74	WR	I	Microprocessor data write signal input
75	CS	I	Chip select signal input (from the microprocessor)
76	RS	I	Register selection signal input
77	V <sub>SS0</sub>	P	
78	SWAIT	O	Sub-CPU wait signal
79	EXCK	O	Sub code I/O
80	MCK	O	Crystal oscillator frequency output
81	TEST0	I	Test inputs. These pins should be tied low in normal operation
82	RCS	O	RAM chip select
83	RWE	O	RAM data write signal output
84	ROE	O	RAM data read signal output
85		NC	
86		NC	
87		NC	
88		NC	
89	V <sub>DD</sub>	P	
90	V <sub>SS1</sub>	P	
91	DB0	B	SCSI connection
92	DB1	B	SCSI connection
93	V <sub>SS1</sub>	P	
94	DB2	B	SCSI connection
95	DB3	B	SCSI connection
96	V <sub>SS1</sub>	P	
97	DB4	B	SCSI connection
98	DB5	B	SCSI connection
99	V <sub>SS1</sub>	P	
100	DB6	B	SCSI connection

Type: I: Input pin, O: Output pin, B: Bidirectional pin, P: Power supply pin, NC: No connection pin

Note: 1. NC must be left open. Do not connect any signals to these pins.

2. V<sub>SS0</sub> is the logic system ground and V<sub>SS1</sub> is the SCSI interface ground. (from the standard cell version)

Continued on next page.

## LC89512W

### Specifications

#### Absolute Maximum Ratings at $V_{SS} = 0\text{ V}$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	$V_{DD\text{ max}}$	$T_a = 25^\circ\text{C}$	-0.3 to +7.0	V
I/O voltages	$V_I, V_O$	$T_a = 25^\circ\text{C}$	-0.3 to $V_{DD} + 0.3$	V
Allowable power dissipation	$P_d\text{ max}$	$T_a \leq 70^\circ\text{C}$	350	mW
Operating temperature	$T_{opr}$		-30 to +70	$^\circ\text{C}$
Storage temperature	$T_{stg}$		-55 to +125	$^\circ\text{C}$
Soldering thermal stress limit (pins only)		10 seconds	260	$^\circ\text{C}$

#### Allowable Operating Ranges at $T_a = -30\text{ to }+70^\circ\text{C}$ , $V_{SS} = 0\text{ V}$

Parameter	Symbol	Conditions	min	typ	max	Unit
Supply voltage	$V_{DD}$		4.5	5.0	5.5	V
Input voltage range	$V_{IN}$		0		$V_{DD}$	V

#### DC Characteristics at $T_a = -30\text{ to }+70^\circ\text{C}$ , $V_{SS} = 0\text{ V}$ , $V_{DD} = 4.5\text{ to }5.5\text{ V}$

Parameter	Symbol	Conditions	min	typ	max	Unit
Input high level voltage	$V_{IH1}$	All input pins other than (1), (3), and XTALCK	2.2			V
Input low level voltage	$V_{IL1}$				0.8	V
Input high level voltage	$V_{IH2}$	$\overline{\text{RESET}}$ , $I_{O0}$ to $I_{O7}$ , $D0$ to $D7$ , $\overline{\text{RD}}$ , $\overline{\text{CS}}$ , $\overline{\text{WR}}$ , $\overline{\text{WFCK}}$ , $\overline{\text{SBSO}}$ and $\overline{\text{SCOR}}(1)$	2.5			V
Input low level voltage	$V_{IL2}$				0.6	V
Input high level voltage	$V_{IH3}$	$\overline{\text{ACK}}$ , $\overline{\text{ATN}}$ and the input pins (3)	2.0			V
Input low level voltage	$V_{IL3}$				0.8	V
Output high level voltage	$V_{OH1}$	$I_{OH1} = -3\text{ mA}$ : $I_{O0}$ to $I_{O7}$ , $D0$ to $D7$ and all output pins other than (2), (3) and XTALCK	2.4			V
Output low level voltage	$V_{OL1}$	$I_{OL1} = 3\text{ mA}$ : $I_{O0}$ to $I_{O7}$ , $D0$ to $D7$ and all output pins other than (2), (3) and XTALCK			0.4	V
Output low level voltage	$V_{OL2}$	$I_{OL2} = 3\text{ mA}$ : $\overline{\text{INT1}}$ and $\overline{\text{INT0}}$ (pull-up resistor open drain) (2)			0.4	V
Output low level voltage	$V_{OL3}$	$I_{OL3} = 48\text{ mA}$ : $\overline{\text{DB0}}$ to $\overline{\text{DB7}}$ , $\overline{\text{DBP}}$ , $\overline{\text{BSY}}$ , $I/O$ , $\overline{\text{MSG}}$ , $\overline{\text{SEL}}$ , $\overline{\text{RST}}$ , $\overline{\text{REQ}}$ , $C/D$ (2)			0.4	V
Input leakage current	$I_L$	$V_I = V_{SS}$ , $V_{DD}$ : All input pins	-25		+25	$\mu\text{A}$
Pull-up resistance	$R_{UP}$	$I_{O0}$ to $I_{O7}$ , $D0$ to $D7$ , $\overline{\text{INT1}}$ and $\overline{\text{INT0}}$	40	80	160	$\text{k}\Omega$

- No products described or contained herein are intended for use in surgical implants, life-support systems, aerospace equipment, nuclear power control systems, vehicles, disaster/crime-prevention equipment and the like, the failure of which may directly or indirectly cause injury, death or property loss.
- Anyone purchasing any products described or contained herein for an above-mentioned use shall:
  - ① Accept full responsibility and indemnify and defend SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors and all their officers and employees, jointly and severally, against any and all claims and litigation and all damages, cost and expenses associated with such use:
  - ② Not impose any responsibility for any fault or negligence which may be cited in any such claim or litigation on SANYO ELECTRIC CO., LTD., its affiliates, subsidiaries and distributors or any of their officers and employees jointly or severally.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of February, 1997. Specifications and information herein are subject to change without notice.